

SPECIFICATION

TITLE OF THE INVENTION

METHACRYLIC RESIN COMPOSITION

5 BACKGROUND OF THE INVENTION

Field of the Invention

The present invention relates to a methacrylic resin composition which is useful as a molding material for preparing a light guide plate by, for example, injection
10 molding, and to use and applications thereof.

Description of Related Art

Since methacrylic resins have a good transparency, they have been used conventionally as a molding material
15 for a light guide plate. Such a light guide plate is generally prepared by injection molding. Regarding a molding material for preparing an optical element such as a light guide plate by injection molding as above, various methacrylic resin compositions have been reported hitherto
20 (see JP 08-269291 A, JP 08-302145 A, JP 08-253650 A, JP 08-280746 A, and JP 2006-298966 A).

SUMMARY OF THE INVENTION

Technical Problem

25 However, a light guide plate which is, for example,

used for a component of a back light unit in various types of liquid crystal displays for laptop personal computers, monitors, and so on may be subjected to a high temperature for a long time in some cases. For these cases, a light
5 guide plate having a high heat resistance is demanded. However, a conventional methacrylic resin composition as above could not prepare a light guide plate of which heat resistance is satisfactory enough.

Thus, the purpose of the present invention is to
10 provide a methacrylic resin composition which can prepare a light guide plate having a good heat resistance, as well as use and applications thereof.

Solution to Problem

15 In order to solve the above problem, the inventors have considered earnestly. As a result, it has been found that a resin composition which comprises a copolymer polymerized from monomeric components comprising methyl methacrylate and acrylic acid ester (in other words,
20 acrylate ester) with a content ratio of methyl methacrylate not smaller than a certain value, and has a reduced viscosity and MFR respectively in certain ranges can prepare a light guide plate having a high heat resistance by, for example, injection molding, and thereby the present
25 invention has been completed.

That is, the present invention has the following constitutions.

(1) A methacrylic resin composition for a light guide plate, characterized in that the methacrylic resin composition comprises a copolymer polymerized from monomeric components comprising methyl methacrylate and acrylic acid ester wherein a content ratio of methyl methacrylate is at least 97% by weight; and a reduced viscosity is 0.46-0.55 dL/g at 25°C measured as a solution at a concentration of 0.5 g/50 mL in chloroform, and MFR is at least 8 g/10 min at 230°C measured under a load of 37.3 N.

(2) The methacrylic resin composition according to the above (1), wherein a content ratio of acrylic acid ester in the monomeric components is at least 0.1% by weight.

(3) The methacrylic resin composition according to the above (1) or (2), wherein the monomeric components comprise 0.02-0.3% by weight of polyfunctional monomer having at least two radical-polymerizable double bonds.

(4) The methacrylic resin composition according to any one of the above (1) to (3), wherein polymerization of the monomeric components is conducted by bulk polymerization.

(5) The methacrylic resin composition according to

any one of the above (1) to (4), which comprises 0.01-1.0% by weight of a mold release agent with respect to a total amount of the methacrylic resin composition.

5 (6) The methacrylic resin composition according to any one of the above (1) to (5), which comprises a thermal stabilizing agent.

(7) The methacrylic resin composition according to any one of the above (1) to (6), which is to be subjected to injection molding.

10 (8) Use of the methacrylic resin composition according to any one of the above (1) to (7) in injection molding to obtain a light guide plate.

(9) A light guide plate which is obtained from the methacrylic resin composition according to any one of the
15 above (1) to (7) by injection molding.

Advantageous Effects of Invention

According to the methacrylic resin composition of the present invention, a following effect is attained: a light
20 guide plate having a high heat resistance can be prepared.

DETAILED DESCRIPTION OF THE EMBODIMENTS

(Methacrylic resin composition)

A methacrylic resin composition of the present
25 invention comprises a copolymer polymerized from monomeric

components comprising methyl methacrylate and acrylic acid ester wherein a content ratio of methyl methacrylate is at least 97% by weight. More specifically, the monomeric components for forming the above copolymer necessarily
5 comprise methyl methacrylate (a) and acrylic acid ester (b), and additionally may comprise a monomer (c) which is copolymerizable with methyl methacrylate or acrylic acid ester.

In the above-described monomeric components, a content
10 ratio of methyl methacrylate (a) is at least 97% by weight, preferably 97-99.9% by weight, and more preferably 97-99.5% by weight. Also in the monomeric components, a content ratio of acrylic acid ester (b) is at most 3% by weight, preferably not smaller than 0.1% by weight, and more
15 preferably not smaller than 0.5% by weight. If the content ratio of acrylic acid ester (b) exceeds 3% by weight, a heat resistance of the obtained molded article (light guide plate) can not be increased enough.

As the above-described acrylic acid ester (b), acrylic
20 acid ester which can reduce a glass transition temperature of the resultant copolymer is mentioned, exemplarily. More specifically, examples thereof are methyl acrylate, ethyl acrylate, propyl acrylate, n-butyl acrylate, sec-butyl acrylate, tert-butyl acrylate, cyclohexyl acrylate, benzyl
25 acrylate, 2-ethylhexyl acrylate, 2-hydroxyethyl acrylate,

cyclopentadiene acrylate, and so on. Among them, methyl acrylate and ethyl acrylate are preferred. As the above-described acrylic acid ester (b), one kind or more than one kind thereof may be used.

5 As to the above-described monomer (c) which is copolymerizable with methyl methacrylate or acrylic acid ester, there are no specific limitations, but monofunctional monomer having one radical-polymerizable double bond and polyfunctional monomer having at least two
10 radical-polymerizable double bonds are mentioned, exemplarily. More specifically, examples of monofunctional monomer having one radical-polymerizable double bond are methacrylic acid ester such as ethyl methacrylate, propyl methacrylate, n-butyl methacrylate, sec-butyl methacrylate,
15 tert-butyl methacrylate, 2-ethylhexyl methacrylate, cyclohexyl methacrylate, benzyl methacrylate, cyclopentadiene methacrylate; unsaturated carboxylic acid or acid anhydride thereof such as acrylic acid, methacrylic acid, maleic acid, itaconic acid, maleic acid anhydride,
20 itaconic acid anhydride; nitrogen-containing monomer such as acrylamide, methacrylamide, acrylonitrile, methacrylonitrile; styrene based monomer such as styrene, α -methylstyrene; and so on. Examples of polyfunctional monomer having at least two radical-polymerizable double
25 bonds are unsaturated carboxylic acid diester of glycol

such as ethylene glycol dimethacrylate, butanediol dimethacrylate; alkenyl ester of unsaturated carboxylic acid such as allyl acrylate, allyl methacrylate, allyl cinnamate; polyalkenyl ester of polybasic acid such as diallyl phthalate, diallyl maleate, triallyl cyanurate, triallyl isocyanurate; unsaturated carboxylic acid ester of polyalcohol such as trimethylolpropane triacrylate; divinylbenzene; and so on. As the above-described monomer (c), one kind or more than one kind thereof may be used.

10 The monomeric components preferably comprise a polyfunctional monomer having at least two radical-polymerizable double bonds which is described in the above regarding the monomer (c). By incorporating such polyfunctional monomer therein, MFR of the resin
15 composition can be increased, and a mold filling property for injection molding can be improved. When the monomeric components comprise the polyfunctional monomer, a content ratio of the polyfunctional monomer in the monomeric components is generally 0.02-0.3% by weight, and preferably
20 0.05-0.1% by weight. If the content ratio of the polyfunctional monomer is too small, MFR may not be increased sufficiently. On the other hand, if the content ratio of the polyfunctional monomer is too high, a mechanical strength of the obtained molded article (light
25 guide plate) may be lowered.

In a preferred embodiment, the monomeric components consist of 97% by weight or more of methyl methacrylate, 2.98% by weight or less of acrylic acid ester, and 0.02-0.3% by weight of polyfunctional monomer having at least
5 two radical-polymerizable double bonds.

A polymerization process for polymerizing the monomeric components is not limited, and any of polymerization processes known in the art, for example, suspension polymerization, solution polymerization, bulk
10 polymerization, and so on can be used. Among them, bulk polymerization is preferred. Bulk polymerization can be conducted by, for example, continuously supplying monomeric components, a polymerization initiator and so on into a reactor while continuously taking out therefrom a partially
15 polymerized material resulted after a prescribed residence time in the reactor, so that a polymer can be obtained with a high productivity.

The polymerization initiator used for polymerizing the monomeric components is not limited, and any of radical
20 polymerization initiators known in the art, for example, an azo compound such as azobisisobutyronitrile, a peroxide such as 1,1-di(t-butylperoxy)cyclohexane, and so on can be used. As the polymerization initiator, one kind or more than one kind thereof may be used.

25 For polymerizing the monomeric components, a chain

transfer agent may be used, if necessary. A chain transfer agent is not limited, but preferable examples thereof are mercaptans such as n-butylmercaptan, n-octylmercaptan, n-dodecylmercaptan, 2-ethylhexylthioglycolate, and so on. As
5 the chain transfer agent, one kind or more than one kind thereof may be used.

A polymerization temperature for copolymerizing the monomeric components is adjusted adequately depending on, for example, a kind and an amount of the radical
10 polymerization initiator which is used, but generally 100°-200°C, and preferably 120°-180°C. If the polymerization temperature is too high, since syndiotacticity of the obtained copolymer is lowered, the obtained molded article (light guide plate) may not have enough heat resistance to
15 maintain its shape.

The methacrylic resin composition of the present invention preferably comprises, together with the above-described copolymer, 0.01-1.0% by weight of a mold release agent with respect to a total amount of the methacrylic
20 resin composition. More preferably, the content ratio of the mold release agent is 0.05-0.5% by weight with respect to the total amount of the methacrylic resin composition. This contributes to improvement in a mold releasing property when the molded article is obtained by injection
25 molding and released from a mold.

As to the above-described mold release agent, there are no limitations, but examples thereof are ester of higher fatty acid, higher fatty alcohol, higher fatty acid, higher fatty acid amide, metal salt of higher fatty acid, and so on. As the mold release agent, one kind or more than one kind thereof may be used.

As the above-described ester of higher fatty acid, more specifically, examples are saturated fatty acid alkyl ester such as methyl laurate, ethyl laurate, propyl laurate, butyl laurate, octyl laurate, methyl palmitate, ethyl palmitate, propyl palmitate, butyl palmitate, octyl palmitate, methyl stearate, ethyl stearate, propyl stearate, butyl stearate, octyl stearate, stearyl stearate, myristyl myristate, methyl behenate, ethyl behenate, propyl behenate, butyl behenate, octyl behenate; unsaturated fatty acid alkyl ester such as methyl oleate, ethyl oleate, propyl oleate, butyl oleate, octyl oleate, methyl linoleate, ethyl linoleate, propyl linoleate, butyl linoleate, octyl linoleate; saturated fatty acid glyceride such as lauric monoglyceride, lauric diglyceride, lauric triglyceride, palmitic monoglyceride, palmitic diglyceride, palmitic triglyceride, stearic monoglyceride, stearic diglyceride, stearic triglyceride, behenic monoglyceride, behenic diglyceride, behenic triglyceride; unsaturated fatty acid glyceride such as oleic monoglyceride, oleic diglyceride,

oleic triglyceride, linolic monoglyceride, linolic diglyceride, linolic triglyceride; and so on. Among them, methyl stearate, ethyl stearate, butyl stearate, octyl stearate, stearic monoglyceride, stearic diglyceride, 5 stearic triglyceride, and the like are preferred.

As the above-described higher fatty alcohol, more specifically, examples are saturated fatty (or aliphatic) alcohol such as lauryl alcohol, palmityl alcohol, stearyl alcohol, isostearyl alcohol, behenyl alcohol, myristyl 10 alcohol, cetyl alcohol; unsaturated fatty (or aliphatic) alcohol such as oleyl alcohol, linolyl alcohol; and so on. Among them, stearyl alcohol is preferred.

As the above-described higher fatty acid, more specifically, examples are saturated fatty acid such as 15 caproic acid, caprylic acid, capric acid, lauric acid, myristic acid, palmitic acid, stearic acid, arachidic acid, behenic acid, lignoceric acid, 12-hydroxyoctadecanoic acid; unsaturated fatty acid such as palmitoleic acid, oleic acid, linoleic acid, linolenic acid, cetoleic acid, erucic acid, 20 ricinoleic acid; and so on.

As the above-described higher fatty acid amide, more specifically, examples are saturated fatty acid amide such as lauric acid amide, palmitic acid amide, stearic acid amide, behenic acid amide; unsaturated fatty acid amide 25 such as oleic acid amide, linoleic acid amide, erucic acid

amide; amides such as ethylene-bis-lauric acid amide, ethylene-bis-palmitic acid amide, ethylene-bis-stearic acid amide, N-oleylstearamide; and so on. Among them, stearic acid amide and ethylene-bis-stearic acid amide are preferred.

As the above-described metal salt of higher fatty acid, examples are sodium salt, potassium salt, calcium salt and barium salt of the above-described higher fatty acid, and so on.

The methacrylic resin composition of the present invention preferably comprises, together with the above-described copolymer, a thermal stabilizing agent for suppressing thermal decomposition of the copolymer. More preferably, the content ratio of the thermal stabilizing agent is 1-2000 ppm by weight with respect to the total amount of the methacrylic resin composition. When the methacrylic resin composition of the present invention is subjected to injection molding so as to mold it into a light guide plate as desired, a molding temperature is set at a higher temperature for the purpose of increasing a molding efficiency in some cases, and addition of the thermal stabilizing agent in these cases contributes to such effect.

As to the thermal stabilizing agent, there are no specific limitations, but a phosphorus thermal stabilizing

agent and an organic disulfide compound are mentioned, exemplarily. Among them, the organic disulfide compound is preferred. As the thermal stabilizing agent, one kind or more than one kind thereof may be used.

5 As the above-described phosphorus thermal stabilizing agent, examples are tris(2,4-di-*t*-butylphenyl)phosphite, 2-[[2,4,8,10-tetrakis(1,1-dimethylethyl)dibenzo [d,f][1,3,2]dioxaphosphepine-6-yl]oxy]-N,N-bis [2-[[2,4,8,10-tetrakis(1,1-dimethylethyl)dibenzo
10 [d,f][1,3,2]dioxaphosphepine-6-yl]oxy]-ethyl]ethanamine, diphenyl tridecyl phosphite, triphenyl phosphite, 2,2-methylenebis(4,6-di-*tert*-butylphenyl)octylphosphite, bis(2,6-di-*tert*-butyl-4-methylphenyl)pentaerythritol diphosphite, and so on. Among them, 2,2-methylenebis(4,6-
15 di-*tert*-butylphenyl)octylphosphite is preferred.

As the above-described organic disulfide compound, examples are dimethyl disulfide, diethyl disulfide, di-*n*-propyl disulfide, di-*n*-butyl disulfide, di-*sec*-butyl disulfide, di-*tert*-butyl disulfide, di-*tert*-amyl disulfide,
20 dicyclohexyl disulfide, di-*tert*-octyl disulfide, di-*n*-dodecyl disulfide, di-*tert*-dodecyl disulfide, and so on. Among them, di-*tert*-alkyl disulfide is preferred, and di-*tert*-dodecyl disulfide is more preferred.

In addition to the copolymer, the mold release agent
25 and the thermal stabilizing agent described above, the

methacrylic resin composition of the present invention may comprise, if necessary, various additives such as an ultraviolet absorbing agent, a light diffusing agent, an antioxidizing agent, an antistatic agent, and so on as long
5 as the present invention does not lose its effects.

When the methacrylic resin composition of the present invention comprises the mold release agent, the thermal stabilizing agent or the various additives (which are hereinafter collectively referred to as "additives"), these
10 additives are incorporated therein by a method, for example, a method (I) wherein the copolymer obtained from polymerization of the monomeric components and the additives are mixed with each other while being heated in a single screw extruder or a twin screw extruder, i.e. melt
15 mixing; a method (II) wherein the monomeric components and the additives are mixed with each other, and the resultant mixture is subjected to a polymerization reaction to obtain the copolymer integrally with the additives; a method (III) wherein the additives adhere to a surface of pellets or
20 beads made of the copolymer described in the above (I), and the additives are mixed with the copolymer at the same time as molding.

The methacrylic resin composition of the present invention has a reduced viscosity of 0.46-0.55 dL/g at 25°C
25 when it is measured as a solution at a concentration of 0.5

g/50 mL in chloroform. The reduced viscosity is preferably 0.47-0.51 dL/g, and more preferably 0.47-0.50 dL/g. If the reduced viscosity is less than 0.46 dL/g, a heat resistance of the obtained molded article (light guide plate) can not
5 be increased enough. On the other hand, the reduced viscosity is more than 0.55 dL/g, a mold filling property for injection molding becomes poor. The reduced viscosity can be within the above range by adjusting an amount of the chain transfer agent which is used for polymerization of
10 the monomeric components. More specifically, the reduced viscosity can be decreased by increasing the amount of the chain transfer agent.

The methacrylic resin composition of the present invention has MFR of at least 8 g/10 min at 230°C when it
15 is measured under a load of 37.3 N in order to assure a mold filling property for injection molding. The MFR is preferably 8-12 g/10 min, and more preferably 8-11 g/10 min. Since MFR depends on a reduced viscosity, a composition of the monomeric components (content ratios of acrylic acid
20 ester and polyfunctional monomer), and a polymerization temperature for polymerizing the monomeric components, the MFR can be within the above range by, for example, adjusting the reduced viscosity and the composition of the monomeric components at a certain polymerization
25 temperature. More specifically, the MFR can be increased

at a certain polymerization temperature by decreasing the reduced viscosity, or by increasing the content ratio of acrylic acid ester in the monomeric components, or by increasing the content ratio of polyfunctional monomer in
5 the monomeric components.

The methacrylic resin composition of the present invention hereinbefore described is useful as a molding material for preparing a light guide plate which requires a high heat resistance, and preferably used inter alia as a
10 molding material subjected to injection molding.

The light guide plate of the present invention is obtained by subjecting the methacrylic resin composition of the present invention described above to injection molding. In more detail, the light guide plate of the present
15 invention is obtained by using the methacrylic resin composition of the present invention as a molding material, filling a mold with the molding material in a melt state (by injection), cooling it, and then releasing a molded article from the mold. More specifically, the light guide
20 plate can be prepared, for example, as follows: the methacrylic resin composition of the present invention is supplied from a hopper, a screw is set back while being revolved, the resin composition is measured into a cylinder, the resin composition is melted, a pressure is applied to
25 the melted resin composition to fill a mold, it is retained

for a certain time period until the mold cools down sufficiently, and then the mold is opened to release the molded article. As to various conditions for preparing the light guide plate of the present invention (e.g. a melt
5 temperature of a molding material, a mold temperature on injecting the mold material into the mold, a pressure at which a pressure is kept after the resin composition fills the mold, and so on), they can be set adequately and are not specifically limited.

10

Examples

The present invention is explained in more detail by examples below, although the present invention is not limited thereto.

15

Measurement of each property of the resin composition obtained in examples and evaluation of the resin composition were conducted as follows.

<Reduced viscosity>

20

Pursuant to ISO 1628-6, 0.5 g of each sample was dissolved into 50 mL of chloroform, and its viscosity was measured at 25°C with the use of Ostwald viscometer.

<MFR (melt mass-flow rate)>

25

Pursuant to JIS-K7210, measurement was conducted at

230°C under a load of 37.3 N, and the measured value was converted into a value per 10 min.

<Heat resistance (Vicat softening temperature)>

5 Pursuant to JIS-K7206 (B50 Method), a Vicat softening temperature was measured by using a heat distortion tester (148-6 series type, YASUDA SEIKI SEISAKUSHO, LTD.). The higher the Vicat softening temperature, the better the heat resistance.

10

(Example 1)

A polymerization reactor equipped with a stirrer was supplied respectively and continuously with a mixture (monomeric components) of 98 parts by weight of methyl methacrylate (hereinafter abbreviated as "MMA"), 2 parts by weight of methyl acrylate (hereinafter abbreviated as "MA"), and 0.1 part by weight of ethylene glycol dimethacrylate (hereinafter abbreviated as "EGDM"); 0.02 part by weight of 1,1-di(t-butylperoxy)cyclohexane as a polymerization initiator; 0.35 part by weight of n-octylmercaptan as a chain transfer agent; di-tert-dodecyl disulfide as a thermal stabilizing agent at an amount which corresponded to about 10 ppm by weight with respect to the total amount of the resin composition finally obtained.

25 The polymerization reaction was conducted at 175°C with an

average residence time of 40 min. Next, a reaction fluid (a partially copolymerized material) which was taken out from the polymerization reactor was transferred to a devolatizing extruder. While unreacted monomeric components were recovered by vaporization, stearic monoglyceride at an amount which corresponded to 0.1% by weight (0.1 part by weight) with respect to the total amount of the resin composition finally obtained, and methyl stearate at an amount which corresponded to 0.03% by weight (0.03 part by weight) with respect to the total amount of the resin composition finally obtained were added thereto as mold release agents. After the material was sufficiently mixed, it was shaped so that the methacrylic resin composition in the form of pellets was obtained.

A reduced viscosity and MFR of the obtained methacrylic resin composition are shown in Table 1. A heat resistance of this resin composition was evaluated by a Vicat softening temperature, and the result is also shown in Table 1.

(Comparative Example 1)

The methacrylic resin composition in the form of pellets was obtained according to similar procedures to Example 1, except for that an amount of MMA in Example 1 was changed to 95 parts by weight; an amount of MA was

changed to 5 parts by weight; and an amount of n-octylmercaptan used as a chain transfer agent was changed from 0.35 part by weight to 0.30 part by weight.

5 A reduced viscosity and MFR of the obtained methacrylic resin composition are shown in Table 1. A heat resistance of this resin composition was evaluated by a Vicat softening temperature, and the result is also shown in Table 1.

10 (Comparative Example 2)

The methacrylic resin composition in the form of pellets was obtained according to similar procedures to Example 1, except for that an amount of MMA in Example 1 was changed to 95 parts by weight; an amount of MA was
15 changed to 5 parts by weight; an amount of n-octylmercaptan used as a chain transfer agent was changed from 0.35 part by weight to 0.20 part by weight; and stearic monoglyceride and methyl stearate used as mold release agents were omitted, and in place of them, stearyl alcohol was used as
20 a mold release agent at an amount which corresponded to 0.1% by weight (0.1 part by weight) with respect to the total amount of the resin composition finally obtained.

A reduced viscosity and MFR of the obtained methacrylic resin composition are shown in Table 1. A heat
25 resistance of this resin composition was evaluated by a

Vicat softening temperature, and the result is also shown in Table 1.

(Comparative Example 3)

5 The methacrylic resin composition in the form of pellets was obtained according to similar procedures to Example 1, except for that an amount of MMA in Example 1 was changed to 95 parts by weight; an amount of MA was changed to 5 parts by weight; and an amount of n-
10 octylmercaptan used as a chain transfer agent was changed from 0.35 part by weight to 0.40 part by weight.

 A reduced viscosity and MFR of the obtained methacrylic resin composition are shown in Table 1. A heat resistance of this resin composition was evaluated by a
15 Vicat softening temperature, and the result is also shown in Table 1.

Table 1

			Example 1	Comparative Example 1	Comparative Example 2	Comparative Example 3
Monomeric components	MMA	parts by weight	98	95	95	95
	MA	parts by weight	2	5	5	5
	EGDM	parts by weight	0.1	0.1	0	0.1
Polymerization initiator		parts by weight	0.02	0.02	0.02	0.02
Chain transfer agent		parts by weight	0.35	0.30	0.20	0.40
Mold release agent	stearic monoglyceride	parts by weight	0.1	0.1	0	0.1
	methyl stearate	parts by weight	0.03	0.03	0	0.03
	stearyl alcohol	parts by weight	0	0	0.1	0
Reduced viscosity		dL/g	0.50	0.56	0.63	0.45
MFR		g/10 min	10	10	5	25
Vicat softening temperature		°C	110	104	106	100

The present application claims priority to Japanese Patent Application No. 2009-138571 filed on June 9, 2009, entitled "METHACRYLIC RESIN COMPOSITION." The contents of
5 that application are incorporated herein by the reference thereto in their entirety.

WHAT IS CLAIMED IS:

1. A methacrylic resin composition for a light guide plate, characterized in that the methacrylic resin composition comprises a copolymer polymerized from monomeric components comprising methyl methacrylate, acrylic acid ester and polyfunctional monomer having at least two radical-polymerizable double bonds wherein a content ratio of methyl methacrylate is at least 97% by weight and a content ratio of polyfunctional monomer having at least two radical-polymerizable double bonds is 0.02-0.3% by weight; and

a reduced viscosity is 0.46-0.55 dL/g at 25°C measured as a solution at a concentration of 0.5 g/50 mL in chloroform, and melt mass-flow rate is at least 8 g/10 min at 230°C measured under a load of 37.3 N.

2. The methacrylic resin composition according to claim 1, wherein a content ratio of acrylic acid ester in the monomeric components is at least 0.1% by weight.

3. The methacrylic resin composition according to any one of claims 1 to 2, wherein polymerization of the monomeric components is conducted by bulk polymerization.

4. The methacrylic resin composition according to any one of claims 1 to 3, which comprises 0.01-1.0% by weight of a mold release agent with respect to a total amount of the methacrylic resin composition.

5. The methacrylic resin composition according to any one of claims 1 to 4, which comprises a thermal stabilizing agent.

5 6. The methacrylic resin composition according to any one of claims 1 to 5, which is to be subjected to injection molding.

10 7. Use of the methacrylic resin composition according to any one of claims 1 to 6 in injection molding to obtain a light guide plate.

15 8. A light guide plate which is obtained from the methacrylic resin composition according to any one of claims 1 to 6 by injection molding.